



Physical Interfaces & Carriers North America TC Chapter

SEMI Standards NA Winter Meetings 2026

Wednesday, February 11

09:00–12:00 Noon Pacific (OVTCCM)

AGENDA

	Time
1 Welcome/Call to Order	09:00
1.1 Log into SVM for voting (https://svm.semi.org/)	
1.2 Required Elements (Membership Requirements, Antitrust and Intellectual Property Reminders, and Effective Meeting Guidelines)	
1.3 Introductions	
1.4 Agenda Review	
2 Review of Previous Meeting Minutes	09:15
3 Liaison Report (Japan)	09:20
4 Staff Report	09:25
5 Ballot Review	09:35
None	
6 Subcommittee & Task Force Reports	09:35
6.1 “6x12” Reticle Carrier & Load Port Task Force	
6.2 Electron Microscopy Workflow Task Force	Break?
6.3 SEMI E72 Revision Task Force	10:30-10:40
6.4 Film Frame FOUP (FFF) Task Force	
6.5 Next Gen Assembly/Test Material Handling Japan Task Force	
6.6 Integrated Workflows in Failure Analysis Task Force	
6.7 Global PIC Maintenance Task Force	
7 Old Business	11:00
7.1 Five-Year Review (<i>None</i>)	



	Time
8 New Business	11:15
9 Action Item Review	11:30
10 Next Meeting and Adjournment	11:40
10.1 The next SEMI Standards NA Meetings are tentatively scheduled for the week of May 11-14, 2026, to be held in-person and virtual in conjunction with ASMC in Albany, New York. Schedule details TBD. https://www.semi.org/en/products-services/standards .	

Tentative Schedule (Eastern):

- TBD, Next Gen Assembly / Test Material Handling (NGAT) Japan TF
- TBD, Integrated Workflows in Failure Analysis TF
- TBD, “6 x12 inch” Reticle Carrier and Load Port TF

Monday, May 11

- Open

Tuesday, May 12

- 15:00-16:00, Electron Microscopy Workflow TF

Wednesday, May 13

- 08:30-09:00, Global PIC Maintenance TF (*tentative, depending on Five-Year Review*)
- 09:00-12:00 Noon, PIC NA TC Chapter Meeting

20260109
LNN
v1